WNSC2D101200D

Silicon Carbide Diode

Rev.01 - 21 June 2022

Product data sheet

1. General description

Silicon Carbide Schottky diode in a TO252 (DPAK) plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- Highly stable switching performance
- High forward surge capability I_{FSM}
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T_{j(max)} = 175 °C)

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Notes	s Values			Unit
Absolute maximum rating							
V _{RRM}	V _{RRM} repetitive peak reverse 1200						V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 151 °C; Fig. 1; Fig. 2; Fig. 3		10		A	
Tj	junction temperature			-55 to 175		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
		I _F = 10 A; T _j = 175 °C; <u>Fig. 5</u>		-	2.00	2.50	V
Dynamic	Dynamic characteristics						
Q _r	recovered charge	$I_F = 10 \text{ A}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s}; V_R = 400 \text{ V};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	22	-	nC



5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	n.c.	not connected		
2	К	cathode [1]		K <u>– K</u> A 001aaa020
3	А	anode		
mb	К	mounting base; connected to cathode		

[1] It is not possible to connect to pin 2 of the TO252 package.

6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number	Packing	Small packing	Package	Package		
	name		method	quantity	version	issue date		
WNSC2D101200D	TO252	WNSC2D101200D6J	Reel	2500	TO252NS	14-Nov-2016		

7. Marking

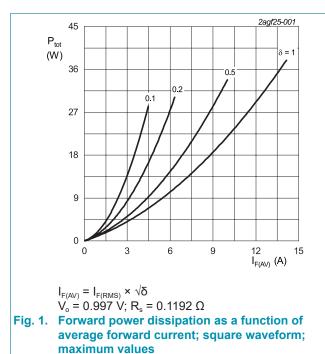
Table 4. Marking codes						
	Type number	Marking codes				
	WNSC2D101200D	WNSC2D				
		10120D				

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V_{RRM}	repetitive peak reverse voltage			1200	V
V_{RWM}	crest working reverse voltage			1200	V
V _R	reverse voltage	DC		1200	V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; T _{mb} ≤ 151 °C; Fig. 1; Fig. 2; Fig. 3		10	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 151 °C; square-wave pulse		20	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		80	А
	forward current	t_p = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse		750	А
l ² t	I ² t for fusing	sine-wave pulse; T _{j(init)} = 25 °C; t _p = 10 ms		32	A ² s
T _{stg}	storage temperature			-55 to 175	°C
T _j	junction temperature			-55 to 175	°C



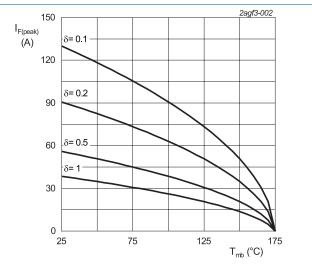
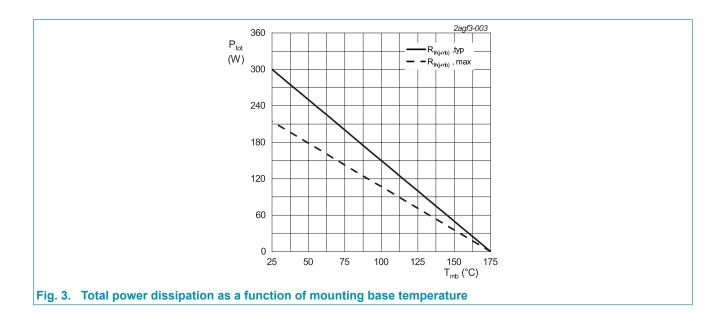


Fig. 2. Current derating as a function of mounting base temperature

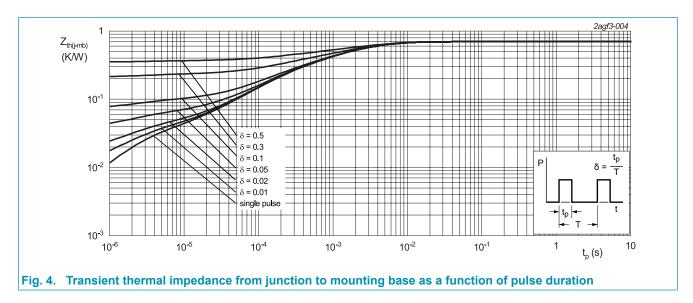
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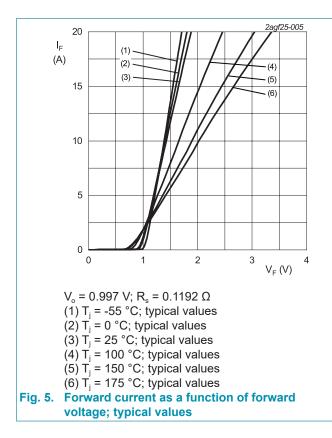
9. Thermal characteristics

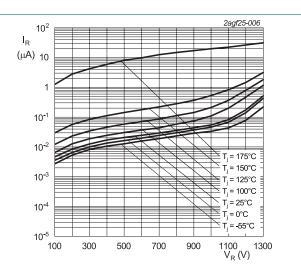
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	with heatsink compound; Fig. 4		-	0.5	0.7	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air		-	40	-	K/W



10. Characteristics

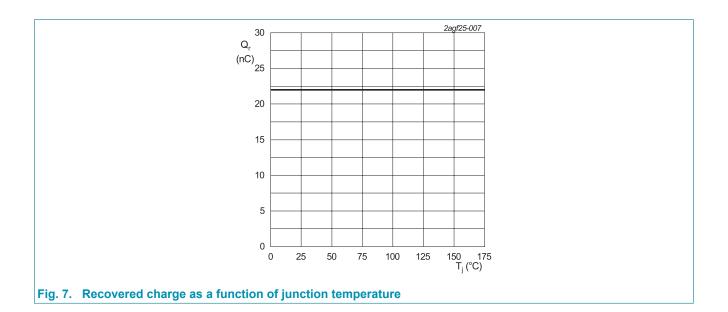
Table 7. Cl	haracteristics						
Symbol	Parameter	Conditions	Notes	Min	Тур	Мах	Unit
Static cha	aracteristics						
V _F	forward current	I _F = 10 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
		I _F = 10 A; T _j = 175 °C; <u>Fig. 5</u>		-	2.00	2.50	V
I _R	reverse current	V _R = 1200 V; T _j = 25 °C; <u>Fig. 6</u>		-	1	50	μA
		V _R = 1200 V; T _j = 175 °C; <u>Fig. 6</u>		-	25	500	μA
Dynamic	characteristics						
Q _r	recovered charge	$I_F = 10 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	22	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C		-	481	-	pF
		f = 1 MHz; V _R = 400 V; T _j = 25 °C		-	42	-	pF
		f = 1 MHz; V _R = 800 V; T _j = 25 °C		-	31	-	pF
E _{as}	non-repetitive avalanche energy	$I_R = 4.2 \text{ A}; \text{ L} = 10 \text{ mH}; \text{ T}_{j(init)} = 25 \text{ °C}$		88	-	-	mJ



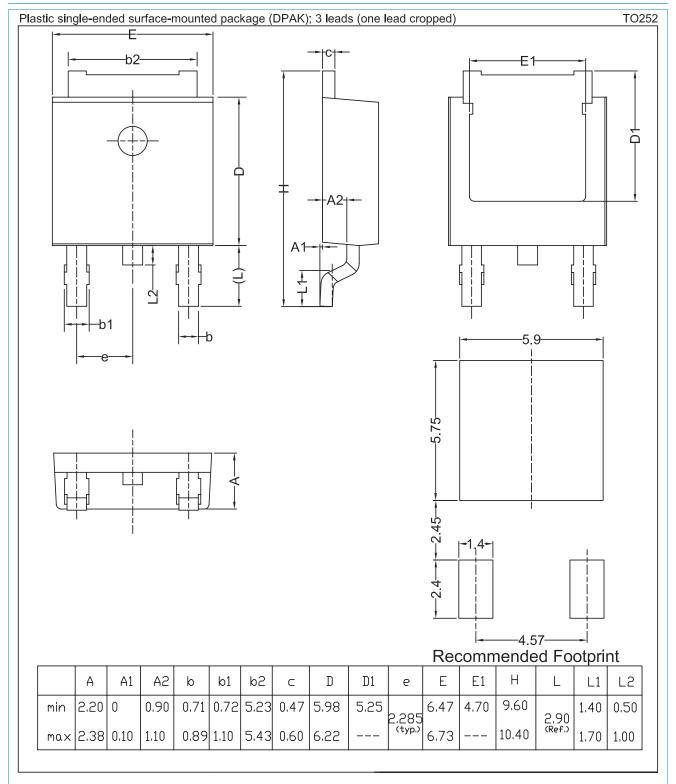




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11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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